

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	125	(250/504H).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 11:42
L5	13	("5420768"   "5457611"   "5624711"   "6102696"   "6200134"   "6318996"   "6331111"   "6468077"   "6517218"   "6523979"   "6611110").PN. OR ("6709128"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/05 11:57
L6	8	L4 and (heat near (sink or dissipat\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 11:58
L7	432	(362/119).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 11:58
L8	12	L7 and (heat near (sink or dissipat\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 11:58
L15	2	("20020133970").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:07
L16	14	("4501151"   "4748985"   "4949708"   "5076276").PN. OR ("5213103").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/05 12:18
L17	9	L16 and (epoxy or polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:21

L18	4875	(heat adj sink) same (epoxy or polymer\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:21
L19	530	L18 and (handpiece or (hand adj piece) or handle)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:22
L20	45	L19 and dental	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:26
L21	485	L19 not L20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:26
L22	79	L21 and medical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:28
L23	406	L21 not L22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:28
L24	2	L23 and (fill\$3 near handle)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:38
L25	4	L23 and (epoxy near heat)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:48

L26	21	L23 and (light near (cure\$1 or curing))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:48
S1	46	(heat adj sink) near polymer\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:11
S2	1	S1 and dental	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 17:55
S3	3	S1 and medical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 17:56
S4	6	S1 and (handpiece or tool or (hand adj piece))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 17:56
S5	53	("20020018338"   "20020041487"   "20020108743"   "20020195232"   "20040226707"   "4619316"   "4663649"   "4703339"   "4888637"   "4894060"   "4900877"   "4926242"   "4938279"   "4999741"   "5006924"   "5049085"   "5077870"   "5168926"   "5248748"   "5285108"   "5315480"   "5366688"   "5430609"   "5440172"   "5443876"   "5513070"   "5523049"   "5523260"   "5552960"   "5572070"   "5602221"   "5620795"   "5653280"   "5660917"   "5738936"   "5745344"   "5781412"   "5790376"   "6026895"   "6048919"   "6060009"   "6093961"   "6106922"   "6204303"   "6280845"   "6348654"   "6372323"   "6385047"   "6410137"   "6465561"   "6547001"   "6616999"   "6680015").PN. OR ("6919504").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/04 17:59

S6	58	(heat adj sink) near epoxy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:11
S7	0	S6 and dental	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:11
S8	2	S6 and medical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:24
S9	14	("4501151"   "4748985"   "4949708"   "5076276").PN. OR ("5213103").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/04 18:17
S10	12	S6 and (conductive near (epoxy or polymer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:27
S11	800	(433/29).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:27
S12	1	S11 and (heat near (epoxy or polymer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:27
S13	0	S11 and (sink near (epoxy or polymer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:28
S14	0	S11 and (sink near plastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:28

S15	1	S11 and (heat near plastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:36
S16	103	S11 and (heat near (sink or dissipat\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:44
S17	41	S16 and epoxy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:55
S18	6	S16 and (conducti\$2 near (epoxy or silicone or polymer\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:58
S19	0	S16 and (sink near (epoxy or silicone or polymer\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:59
S20	1	S16 and (heat near (epoxy or silicone or polymer\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:59